High-selectivity neural probe based on a Fabry–Perot optical filter and a CMOS silicon photodiodes array at visible wavelengths

Sara Pimenta
José P. Pereira
Nuno M. Gomes
João F. Ribeiro
Manuel F. Silva
Sandra B. Goncalves
Graca Minas
José H. Correia

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Sara Pimenta,* José P. Pereira, Nuno M. Gomes, João F. Ribeiro, Manuel F. Silva, Sandra B. Goncalves, Graca Minas, and José H. Correia

University of Minho, CMEMS-UMinho, Campus de Azurém, Guimarães, Portugal

Abstract. This paper presents a silicon neural probe with a high-selectivity optical readout function and light emitting diodes for neurons photostimulation and fluorophore excitation. A high-selectivity Fabry–Perot optical filter on the top of a CMOS silicon photodiodes array can read the emitted fluorescence, which indicates the neurons physiological state. The design, fabrication, and characterization of the optical filter are presented. The $\text{SiO}_2/\text{TiO}_2$ based optical filter thin films were deposited by RF sputtering. The performance of the optical filter deposited on the top of the silicon photodiodes array, implemented in the neural probe, was tested through *in-vitro* fluorescence measurements. The transmittance peak of the fabricated optical filter is 81.8% at 561 nm, with a full width at half maximum of 28 nm. The peak responsivity of the CMOS silicon photodiode with the optical filter deposited on its top is 273.6 mA/W at 578 nm. The *in-vitro* fluorescence measurements results show a CMOS photodiode current proportional to the fluorophore concentration with a good linearity ($R^2 = 0.9361$). The results validate the use of the neural probe with the high-selectivity optical readout function to determine the presence of different fluorophore concentrations. The development of the device in a conventional CMOS process allows on-chip electronics readout. © 2018 Society of Photo-Optical Instrumentation Engineers (SPIE) [DOI: 10.1117/1.JBO.23.10.105004]

Keywords: high-selectivity neural probe; CMOS silicon photodiodes array; Fabry–Perot optical filter; *in-vitro* fluorescence measurements.

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1 Introduction

Globally, millions of people suffer from mental disorders, such as schizophrenia, affecting about 23 million people; dementia, affecting ~50 million people; bipolar affective disorder, which affects about 60 million people; and depression, which affects 300 million people.¹

In basic neuroscience, implantable neural electrodes are broadly used to study the function and behavior of the central nervous system.² Brain–computer interfaces (such as neural probes) interact with the central nervous system to simplify understanding, mitigating, and treating neurological disorders.³

New techniques have emerged from the scientific development of neuroscience, such as optogenetics. Optogenetics has become a widely used technique for the study of the brain dynamics and circuitry of neurological disorders.⁴ In optogenetics, neuron cells are genetically modified to make them light sensitive, providing excitatory or inhibitory control of the neural activity with high spatiotemporal specificity.^{5,6} Accordingly, opsins are introduced into the brain.⁵ The targeted neuron cells express the introduced opsin and, when exposed to light in a specific wavelength, a biological effect on those specific cells is promoted.⁵ Thus, the rise of optogenetics has opened the chance to use light to address and generate action potentials in specific cells.⁷ For example, the channelrhodopsin-2 (ChR2) is a protein whose cation channel is directly activated by blue light (at ~470 nm).⁸ ChR2 allows the cation inflow of Ca^{2+} , promoting cell depolarization.⁹ In addition to

Ca^{2+} inflow, after the blue light stimulation, it is possible to use a fluorophore coelectroporated into the neuron cells, such as a genetically encoded calcium indicator for optical imaging (GECO).⁹ The O-GECO1 is such an example, it is a fluorophore with an increased capacity of fluorescence when bonded to Ca^{2+} .¹⁰ When O-GECO1 is bonded to Ca^{2+} and it is excited with green light (at ~540 nm), it emits fluorescence with an emission peak at ~570 nm.^{10,11} As a result, neuron cells respond to photostimulation and their physiological state can be determined based on fluorescence.⁹

Several authors have developed neural devices with CMOS image sensors for fluorescence imaging or intrinsic signal imaging.^{12,13} Kobayashi et al.⁹ reported an implantable device with a CMOS image sensor and dual light emitting diodes (LEDs) for photostimulation and fluorescence imaging. The authors reported the use of blue LEDs for photostimulation, green LEDs for fluorescence excitation, and an absorption filter (long-pass liquid photoresist filter: >600 nm) superimposed on the CMOS image sensor, to pass the fluorescence and intercept the stimulation and excitation light. The bottleneck of these solutions is the selectivity of the optical readout function for different wavelengths in the visible region of the spectrum.

Thus, in this paper it is presented the fabrication of a silicon neural probe (see Fig. 1) with LEDs for photostimulation and fluorophore excitation. A CMOS silicon photodiodes array was also implemented in the neural probe to detect the emitted fluorescence and a high-selectivity Fabry–Perot optical filter was deposited on top of the photodiodes array. The extracted

*Address all correspondence to: Sara Pimenta, E-mail: sara.pimenta@dei.uminho.pt

Fig. 1 Design of the optical silicon neural probe with: LEDs and the CMOS silicon photodiodes array with the high-selectivity Fabry–Perot optical filter deposited on its top.

fluorescence signal will be more reliable, selective, and sensitive to small intensity emissions if the optical filter takes into account the emission peak of the molecule, whose emitted fluorescence will be detected (~ 570 nm for the O-GECO1). This paper presents the design, fabrication, and characterization of an optical filter for the reported application. Moreover, the validation of the fabricated optical filter on the top of a CMOS silicon photodiodes array implemented in the neural probe was achieved, performing *in-vitro* fluorescence measurements with a fluorophore with excitation and emission properties similar to the O-GECO1. This is the first description of a silicon neural probe with a high-selectivity optical readout function.

2 Design and Fabrication

2.1 CMOS Silicon Photodiodes Array

The CMOS silicon photodiodes array (2×2) was designed and fabricated in a *p*-type silicon wafer. The photodiodes are *n*+/*p*-epilayer type, which are the ones more suitable for the visible spectral region. Each photodiode active area is $100 \mu\text{m} \times 100 \mu\text{m}$. The measured responsivity as a function of the wavelength is shown in Fig. 2. The responsivity measurement was performed using a pinhole with $100\text{-}\mu\text{m}$ diameter in one commercial photodiode (Hamamatsu S1336-5BQ), used as a reference to extract the CMOS photodiode responsivity curve. Moreover, the measurement was performed using an optical setup comprising: a quartz tungsten halogen lamp at 200 W (Newport 6334NS) with a light incident angle of 0 deg, a picoammeter (Keithley 487), a monochromator (Newport 74125), and an optical fiber (Newport 77563). The responsivity experimental measurement was performed with 0-deg light incident angle, which is appropriated to the final device configuration, where the illumination is in the same face of the detection.

The CMOS silicon photodiodes array was fabricated in a conventional double-metal single-polysilicon $0.7\text{-}\mu\text{m}$ *n*-well CMOS process. After completion of the standard CMOS process, a postprocessing module for deposition of thin films and blade dicing techniques were performed to produce a neural probe with the pad contacts for the commercial GaN/sapphire LEDs. The neural probe pads, the interconnected lines, and the contacts were made of titanium (15-nm thick), aluminum (200-nm thick), and platinum (60-nm thick) thin films, patterned with photolithography techniques and deposited with e-beam

Fig. 2 Responsivity as a function of wavelength for the CMOS silicon photodiode.

(titanium and aluminum) and DC sputtering (platinum). Blade dicing allowed to define the probe geometry. All cuts were carried out by a high-precision DAD 2H/6T (DISCO Corporation) dicing saw, with a blade (NBC-ZB 2050, DISCO) suitable for silicon samples sawing.¹⁴ Cutting parameters were: (1) $0.3 \text{ mm} \cdot \text{s}^{-1}$ speed; (2) Z-axis step = 0 mm, which determines the maximum cut depth of the blade as the neural probe is expected to be detached from the wafer; (3) X-axis step = 50 mm, it sets the length of the cut, and therefore the length of the probe (8 mm); and (4) Y-axis step = $700 \mu\text{m}$, which establishes the probe width.

2.2 Optical Filter Structure and Simulation

The Fabry–Perot structure is a simple interferometer, where the incident light suffers multiple reflections between the coated surfaces that define the cavity. The emerging wavefronts interfere constructively only if there is no phase difference between them. At other wavelengths, destructive interference of the transmitted wavefronts reduces the transmitted intensity toward to zero. Therefore, this device acts as a filter that transmits certain wavelengths and reflects the others back to the light source.

The implemented Fabry–Perot optical filter has dielectric mirrors, featuring low-energy absorption rates, and high transmittance at a specific range of wavelengths.¹⁵ The optical filter multilayer is composed of 11 thin films with high and low refractive index materials, alternatively (see Fig. 3).

The Fabry–Perot operation principle is presented in Eq. (1):

$$\lambda q = 2n_r d_r, \quad (1)$$

where λ is the transmitted wavelength, q is the filter interference order (it was used $q = 1$), n_r is the refractive index of the resonant cavity material, and d_r is the thickness of the resonant cavity.¹⁵

The thickness of each film (d) that forms each mirror multilayer is also related to the transmitted wavelength (λ), considering Eq. (2):

$$\lambda = 4nd, \quad (2)$$

where n is the refractive index of each film material.¹⁵

Fig. 3 Structure of the optical filter with dielectric mirrors: H—mirror layer with high refractive index material, L—mirror layer with low refractive index material, and LL—resonant layer with low refractive index material.

For the reported application, it is expected to have an optical filter with a transmittance peak close to 570 nm. The optical filter was computationally designed using the software TFCalc™ 3.5, in which the experimental refractive indices of the used materials were set in the database. The dielectric materials used as high and low refractive index materials were TiO₂ and SiO₂, respectively. The experimental refractive indices of these materials are reported in Ref. 16 (1.47 for SiO₂ and 2.4 for TiO₂, at 550 nm), considering the fabrication process of the optical filter, RF sputtering (see Sec. 2.3).

The resonant cavity thickness and the thicknesses of each thin film that forms each mirror multilayer are shown in Table 1. The thicknesses of each film that forms each mirror multilayer were calculated using as reference a central wavelength of 550 nm and Eq. (2). The resonant cavity thickness was obtained using Eq. (1) and adjusted on TFCalc™ 3.5 software.

Table 1 Optical filter layers thickness.

Material	Thickness (nm)
TiO ₂	57
SiO ₂	94
TiO ₂	57
SiO ₂	94
TiO ₂	57
SiO ₂	206
TiO ₂	57
SiO ₂	94
TiO ₂	57
SiO ₂	94
TiO ₂	57

Fig. 4 Transmittance of the simulated optical filter extracted from TFCalc™ 3.5.

The simulation result (from TFCalc™ 3.5) is shown in Fig. 4. The transmittance of the optical filter at 570 nm is ~83.5%, with a full width at half maximum (FWHM) of ~15 nm.

2.3 Optical Filter Fabrication

Both SiO₂ and TiO₂ thin films were deposited by RF sputtering. The SiO₂ thin films were deposited from a ceramic target (SiO₂, 99.995% pure) with 150 W power supply. An Ar flow rate of 15 sccm was used and a pressure of 8.5 × 10^{−4} mbar was maintained during deposition. A deposition rate of 0.6 Å/s was measured through a quartz crystal sensor. The TiO₂ thin films were deposited from a metallic target (Ti, 99.7% pure) with 200 W power supply. The reactive RF sputtering was used with Ar + O₂ flow rate atmosphere of 10 and 2 sccm, respectively. A pressure of 2 × 10^{−3} mbar was maintained during deposition and a deposition rate of 0.15 Å/s was measured through a quartz crystal sensor.

The optical filter was deposited on the neural probe (on the top of the CMOS silicon photodiodes array) and in a borosilicate glass substrate (for further optical transmittance characterization). The interface between the optical filter and the CMOS silicon photodiodes is a very thin (to reduce its optical influence on the spectral response) oxide passivation layer, done as a final step of the CMOS process.

3 Optical Filter Characterization: Results and Discussion

3.1 Optical Filter Thin Films

The thickness of the deposited TiO₂ and SiO₂ thin films were measured using a profilometer (Veeco Dektak 150). Table 2 shows the experimental thickness obtained for each layer. Comparing the obtained results with the theoretical thicknesses shown in Table 1, there are some differences that can be related with the calibration of the quartz crystal sensor used for real-time thickness measurement during each deposition. Additionally, a slight reduction in the resonant cavity thickness was performed intentionally during the depositions, considering an increase in the thickness of each film that forms the first mirror multilayer and its affectation on the final optical filter

Table 2 Experimental optical filter layers thickness.

Material	Thickness (nm)
TiO ₂	74
SiO ₂	82
TiO ₂	77
SiO ₂	94
TiO ₂	76
SiO ₂	148
TiO ₂	76
SiO ₂	90
TiO ₂	71
SiO ₂	91
TiO ₂	74

performance (simulated on TFCalc™ 3.5). Thus, the resonant cavity thickness was programmed to 160 nm, instead of 206 nm.

3.2 Optical Filter Transmittance

The transmittance of the fabricated optical filter was measured and shown in Fig. 5. The transmittance measurement was performed using the borosilicate glass substrate and an optical setup comprising: a quartz tungsten halogen lamp at 200 W (Newport 6334NS) with a light incident angle of 0 deg, a picoammeter (Keithley 487), a monochromator (Newport 74125), an optical fiber (Newport 77563), and a commercial photodiode (Hamamatsu S1336-5BQ). Moreover, it is also presented the simulated transmittance of the optical filter (on TFCalc™ 3.5) using the thickness of each layer shown in Table 2. The optical results are close to the ones obtained with the profilometry results (Table 2). The transmittance peak of the fabricated optical filter is

Fig. 5 Experimental transmittance of the fabricated optical filter and the transmittance obtained with the TFCalc™ 3.5 using the experimental thicknesses of Table 2.

~81.8% at 561 nm, with an FWHM of ~28 nm. The experimental transmittance measurements and the simulations on TFCalc™ 3.5 were performed with 0-deg light incident angle, which is important to ensure a correct comparison between the experimental and theoretical results. Moreover, 0-deg light incident angle is appropriated to the final device configuration, where the illumination is in the same face of the detection.

3.3 Responsivity

The responsivity of the CMOS silicon photodiode with the optical filter deposited on its top is shown in Fig. 6. The responsivity measurement was performed using a pinhole with 100-μm diameter in one commercial photodiode (Hamamatsu S1336-5BQ), used as a reference to extract the CMOS photodiode with the optical filter responsivity curve. Moreover, the measurement was performed using an optical setup comprising: a quartz tungsten halogen lamp at 200 W (Newport 6334NS) with a light incident angle of 0 deg, a picoammeter (Keithley 487), a monochromator (Newport 74125), and an optical fiber (Newport 77563). The responsivity experimental measurement was performed with 0-deg light incident angle, which is appropriated to the final device configuration, where the illumination is in the same face of the detection. The responsivity presents a peak of ~273.6 mA/W at 578 nm. As previously referred, the interface between the optical filter and the CMOS silicon photodiodes is a very thin oxide passivation layer (SiO₂ thin film with ~20 nm). This layer is crucial to the final performance of the CMOS photodiodes with the optical filter deposited on their top. The authors have previously tested the direct deposition of the optical filter on the photodiodes top without the passivation layer, which resulted in a poor performance of the set. Moreover, the CMOS silicon photodiode responsivity values shown in Fig. 6 are slightly increased when comparing with Fig. 2. This can be due to light alignment issues during the responsivity characterizations, using a pinhole with 100-μm diameter in one commercial photodiode (Hamamatsu S1336-5BQ), used as a reference to extract the responsivities curves (Figs. 2 and 6). Finally, the optical filter has a transmittance peak at 561 nm and the CMOS photodiode with the optical filter has a responsivity peak at 578 nm. This difference can be related with two factors: the interface between the optical filter and the CMOS silicon photodiodes, an extra 20-nm-thick SiO₂ layer;

Fig. 6 Responsivity as a function of wavelength for the CMOS silicon photodiode with the optical filter deposited on its top.

Fig. 7 Emission spectra of the fluorophore for several concentrations: curves a (0.023 mg/mL), b (0.017 mg/mL), and c (0.014 mg/mL).

and the characteristic responsivity curve of the CMOS photodiode, small increase for higher wavelengths.

4 Fluorescence Measurements: Results and Discussion

4.1 Fluorophore Characterization

For the characterization of the implemented optical filter in the neural probe, it was used a fluorophore with excitation and emission properties similar to the O-GECO1. The molecule (C2734 Sigma-Aldrich, 5-Carboxytetramethylrhodamine) is specified with an excitation wavelength of ~ 543 nm and an emission wavelength of ~ 570 nm, in methanol.¹⁷ To clarify these features, it is important to perform a spectral characterization of the molecule. Fluorescence measurements were performed using a commercial setup and considering an excitation light wavelength of 543 nm. The commercial setup comprised: a quartz tungsten halogen lamp at 200 W (Newport 6334NS), a monochromator (Newport 74125) fixed at 543 nm, a second monochromator (Oriel Instruments 74000) to measure the emission fluorescence, an optical fiber (Newport 77563), a picoammeter (Keithley 487), and a commercial photodiode (Hamamatsu S1336-5BQ).

The fluorescence measurements allowed the determination of the fluorophore emission spectrum as shown in Fig. 7. The curves a, b, and c correspond to different fluorophore concentrations, 0.023, 0.017, and 0.014 mg/mL, respectively. The fluorophore emits fluorescence especially between 550 and 650 nm, with an emission peak at ~ 585 nm. Thus, the peak responsivity of the CMOS silicon photodiode with the optical filter deposited on its top, implemented in the neural probe, covers the fluorophore emission (see Fig. 6).

4.2 In-Vitro Characterization

In-vitro fluorescence measurements were performed to validate the fabricated optical filter on the top of the CMOS silicon photodiodes array, implemented in the neural probe. It was used a front face geometry, which means illumination in the same face of the detection.

The obtained CMOS photodiode current as a function of the fluorophore concentration is shown in Fig. 8. The photodiode current is proportional to the fluorophore concentration. Moreover, the results show a good linearity as the R^2 value is

Fig. 8 CMOS silicon photodiode current as a function of the fluorophore concentration.

close to the unity, which validates the use of the neural probe with the high-selectivity optical readout function to determine the presence of different concentrations of a fluorophore, with excitation and emission properties similar to O-GECO1.

The neural probe integrating two commercial GaN/sapphire LEDs from Roithner LaserTechnik GmbH and the CMOS silicon photodiodes array with a selectivity Fabry–Perot optical filter deposited on its top is shown in Fig. 9. The commercial blue LED ensures 1 mW/mm² emission irradiance for optogenetic activation.¹⁸

Figure 10 shows a general performance of the developed device. The developed device rejects part of the fluorophore excitation light, which is important to measure the fluorescence emission with a low interference from the excitation light. However, the device does not reject light from photostimulation. This may not seem like an issue as the photostimulation can be performed only during a few seconds during the fluorescence acquisition, as reported by Kobayashi et al.⁹ Nevertheless, the control of the thickness of the thin films that forms the optical filter may be improved on the future, improving the calibration of the quartz crystal sensor used for real-time thickness measurement during each deposition. Improving the thin films thicknesses, the performance of the filter will also improve, concerning the rejection of photostimulation and excitation lights. Finally, the developed device presents a great advantage as the optical filter on the top of the CMOS photodiodes array is a multilayer of dielectric materials, which are materials with low absorption coefficient, being the optical filter transmittance complementary to its reflectance.

Fig. 9 Neural probe integrating the commercial LEDs and the CMOS silicon photodiodes array with the high-selectivity Fabry–Perot optical filter.

Fig. 10 General performance of the developed device.

5 Conclusions

This paper validates the use of a high-selectivity Fabry–Perot optical filter on the top of a CMOS silicon photodiodes array, implemented in a neural probe, for the detection of fluorescence signals, emitted by a fluorophore with excitation, and emission properties similar to O-GECO1.

The SiO₂/TiO₂ Fabry–Perot optical filter was fabricated by RF sputtering and has a transmittance of ~81.8% at 561 nm and an FWHM of ~28 nm. The responsivity of the CMOS silicon photodiode with the optical filter deposited on its top is ~273.6 mA/W at 578 nm. The interface between the optical filter and the CMOS silicon photodiodes array is a very thin layer of SiO₂ (20-nm thick), crucial for a good performance of the set. *In-vitro* fluorescence measurements with a fluorophore showed a CMOS photodiode current proportional to the fluorophore concentration, with a good linearity ($R^2 = 0.9361$).

The development of all device in a conventional CMOS process (only a postprocessing module to build the optical filter was added) allows on-chip electronics readout. The future implementation of a CMOS silicon photodiodes array, with higher density and lower photodiode size, in a neural probe can provide enhanced spatial resolution for future *in-vivo* fluorescence measurements. Additionally, an optical filters array can be implemented and the thickness of the resonator SiO₂ layer, which is enclosed between the two dielectric mirrors, can be used as the gap-setting layer for obtaining four different optical filters, i.e., only controlling the thickness of the resonator SiO₂ layer, an optical filter for a specific spectral range of interest can be obtained. This key advantage enables us to easily obtain miniaturized and low-cost narrow bandwidth multispectral devices.¹⁹

Disclosures

The authors have no relevant financial interests in the manuscript and no other potential conflicts of interest to disclose.

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Sara Pimenta received her MSc degree in biomedical engineering (major in medical electronics) from the University of Minho, Portugal, in 2012. In 2017, she received her PhD also in biomedical engineering at University of Minho, Portugal. Currently, she is a postdoctoral researcher at CMEMS-UMinho. Her current research interests include development of microsystems for biomedical applications, optics, neuroscience, and microfabrication.

José P. Pereira is currently working toward his MSc degree in industrial electronics and computers engineering with the CMEMS-UMinho, Portugal. His research interests include optical communication with brain cells, optical filters simulation and fabrication, and microtechnologies.

Nuno M. Gomes graduated in materials engineering in 2002 from University of Minho, Portugal. Currently, he is a researcher at CMEMS-UMinho. His research interests include microfabrication for optics applications.

João F. Ribeiro graduated in industrial electronics engineering (integrated master) from University of Minho, Portugal, in 2010. In 2015, he received his PhD at the same institution. During his PhD, he spent 10 months at LRCS, University of Picardie Jules Verne, France. Currently, he is a postdoctoral researcher at CMEMS and an invited professor of industrial electronics department from the University of Minho. His professional interests are micro/nanofabrication technologies and integrated microsystems for biomedical applications.

Manuel F. Silva graduated in informatics from the Polytechnic Institute of Cávado and Ave, Portugal, in 2008. In 2010, he obtained his MSc degree on micro/nanotechnologies from the University of Minho, Portugal. In 2015, he received his PhD in industrial electronics from the same institution. His past work focused on thermoelectric materials and fabrication of energy harvesting systems. Since 2011, he is involved in the research of optical microsystems and materials technology for medical devices.

Sandra B. Goncalves graduated in biomedical engineering (integrated masters) with the major in medical electronics, at the University of Minho, Portugal, in 2012. Currently, she is a PhD student at University of Minho, over the MIT-Portugal Program within the EDAM focus-area. During her PhD, she spent one year at MIT, in Boston, USA, working in the Synthetic Neurobiology Group. Her scientific interests are in the design and development of MEMS, neuroscience, and optoelectronics and microfabrication technologies.

Graca Minas graduated in industrial electronics engineering in 1994, received her MSc degree in 1998, and her PhD in 2004, all from University of Minho, Portugal. She is an associate professor, at the Department of Industrial Electronics, University of Minho, developing her research work in CMEMS, where she is involved in biomedical microdevices, on-chip integration of electronic circuits, and cointegration of optical filters on CMOS technique and sensors.

José H. Correia graduated in physical engineering from the University of Coimbra, Portugal, in 1990. In 1999, he received his PhD at the Laboratory for Electronic Instrumentation, Delft University of Technology, the Netherlands, working in the field of microsystems for optical spectral analysis. Currently, he is a full professor in the Department of Industrial Electronics, University of Minho, Portugal. He was the general-chairman of Eurosensors 2003 and MME 2007, Guimarães, Portugal.